

3 |

NUTES:

1. MATERIAL:

HOUSING: HIGH TEMPERATURE PLASTIC, UL94 V-0, BLACK COLOR,

CONTACTS: COPPER ALLOY PEGS: COPPER ALLOY

2 FINISH:

CONTACTS: SELECTED GOLD PLATING ON THE CONTACT AREA.

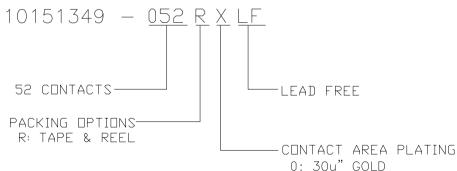
1u" GOLD PLATING ON THE SOLDERTAILS.

50u" NICKEL UNDERPLATING OVER ALL.

PEGS: 120u" MATTE-TIN OVER 50u" MIN. NICKEL.

- 3. CARD THICKNESS APPLIES ACROSS TABS AND INCLUDES PLATING AND/OR METALLIZATION.
- 4. EDGE BEVEL MUST BE PRESENT AND FREE OF CUTTING BURRS FROM PCB AND CONTACT MATERIALS.
- 5. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN RE-FLOW APPLICATIONO.
- 6. PRODUCT SPECIFICATION:GS-12-1513

PRODUCT NUMBER CODE



1: 10 u" GOLD 2: GOLD FLASH

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form: A4mmXLc-2016-02-24

STATUS:Released Printed: May 27, 2020

